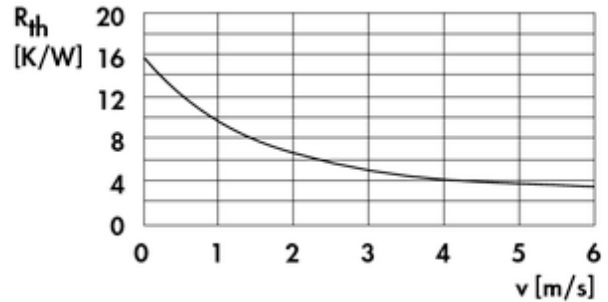
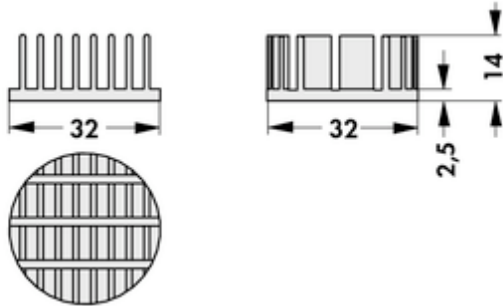


Heatsinks for LEDs / **ICK LED R 32 x 14 G**



Ø 32 x 14 mm, for IC design LED

Parameters of article ICK LED R 32 x 14 G

- R_{th} [K/W]** ⓘ 15.23
- dissipation loss [W]** ⓘ 7.6
- mounting method** therm. conductive foil / therm. cond. adhesive
- socket** universal
- suitable for processor type** universal
- Ø [mm]** ⓘ 32
- height [mm]** 14
- plate thickness [mm]** 2.5
- surface treatment** black anodised

Accessories/ related articles

- Thermally conductive foil both sides adhesive / **WLFT 404 D 32**
- Thermally conductive foil both sides adhesive / **WLFT 405 D 32**